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K. J. J. J.
12/17/03
Docket No.: M4065.0468/P468
(PATENT)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:
Phillip E. Byrd, et al

Application No.: 09/941,761

Group Art Unit: 2812

Filed: August 30, 2001

Examiner: A. Stevenson

For: METHOD AND STRUCTURE FOR
TEMPORARILY ISOLATING A DIE FROM
A COMMON CONDUCTOR TO
FACILITATE WAFER LEVEL TESTING

REQUEST FOR ACKNOWLEDGEMENT OF
INFORMATION DISCLOSURE STATEMENT

Commissioner for Patents

Washington, DC 20231

Dear Sir:

It is respectfully requested that the Information Disclosure Statements filed January 8, 2002 and November 13, 2002, be acknowledged by the Examiner in charge of this application. Specifically, the Examiner is requested to initial and return the Information Disclosure Citations appended to the Information Disclosure Statements filed January 8, 2002 and November 13, 2002.

Dated: May 13, 2003

Respectfully submitted,

By

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